



ULTRA LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Product Summary

V _{BR} (MIN)	IPP (MAX)	C _{T (TYP)}
8V	1.5A	0.23pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Ultra-Small, Low Profile Leadless Surface Mount Package (0.6mm*0.3mm*0.3mm)
- Provides ESD Protection per IEC 61000-4-2 Standard:
 Air ±15kV, Contact ±15kV
- 1 Channel of ESD Protection
- Ultra Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X2-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin over Copper Leadframe, Solderable per MIL-STD-202, Method 208 3
- Weight: 0.0002 grams (Approximate)



Top View



Device Schematic

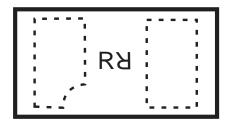
Ordering Information (Notes 4 and 5)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D7V0X1B2LP3-7	Standard	RN	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 5. Package is non-polarized. Parts may be on reel in orientation as illustrated, 180° rotated, or mixed (both ways).

Marking Information



R뇝 = Product Type Marking

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I _{PP}	1.5	Α	8/20µs, Per Figure 3
ESD Protection – Contact Discharge	V _{ESD_CONTACT}	±15	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_AIR}	±15	kV	IEC 61000-4-2 Standard

Thermal Characteristics

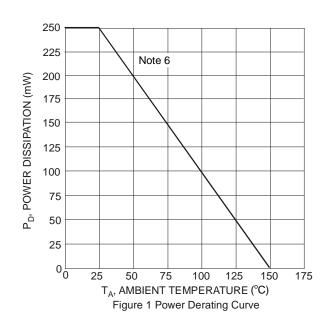
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 6)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

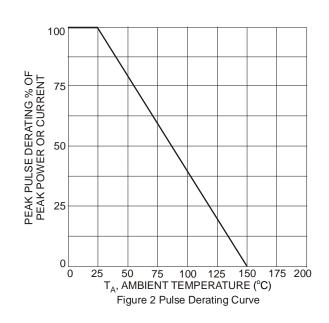
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	_	_	7.0	V	_
Channel Leakage Current (Note 7)	I _{RM}	_	_	200	nA	V _{RWM} = 7.0V
Breakdown Voltage	V _{BR}	8.0	_	_	V	I _R = 1mA
Clamping Voltage	V _{CL}	_	_	14	V	I _{PP} = 1A, t _P = 8/20μs
Channel Input Capacitance	C _T	_	0.23	0.4	pF	V _R = 2.5V, f = 1MHz
		_	0.3	_	pF	$V_R = 0V$, $f = 1MHz$

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect.

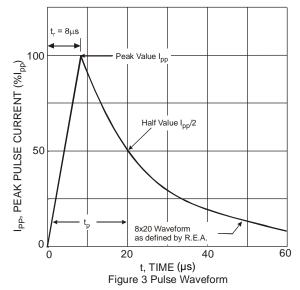


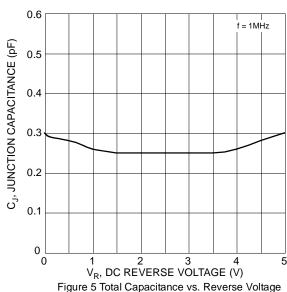


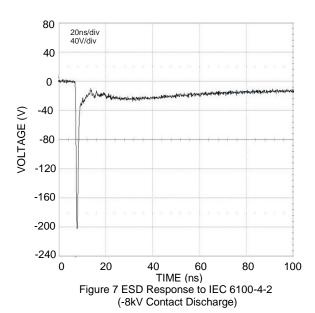
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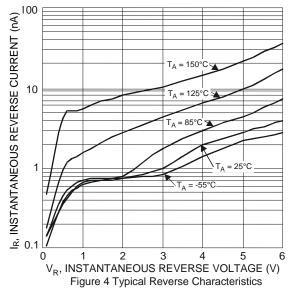
^{6.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

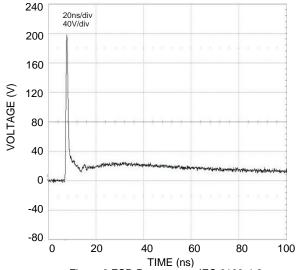




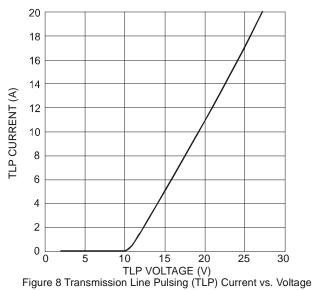








TIME (ns)
Figure 6 ESD Response to IEC 6100-4-2 (+8kV Contact Discharge)

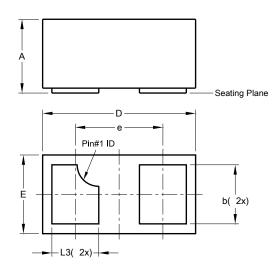




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0603-2

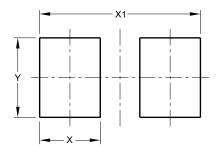


X2-DFN0603-2					
Dim	Min	Max	Тур		
Α	0.27	0.35	0.30		
A 1	0.00	0.03	0.02		
b	0.19	0.29	0.24		
D	0.595	0.645	0.62		
Е	0.295	0.345	0.32		
е	_	_	0.355		
L3	0.14	0.24	0.19		
All	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0603-2



Dimensions	Value (in mm)		
Х	0.230		
X1	0.610		
Y	0.300		



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